



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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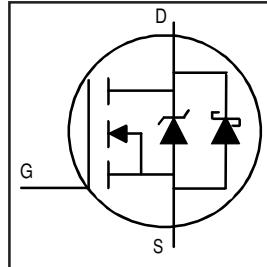
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Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

**PRELIMINARY**

**FETKY™ MOSFET & SCHOTTKY RECTIFIER**

- Copackaged HEXFET® Power MOSFET and Schottky Diode
- Generation 5 Technology
- Logic Level Gate Drive
- Minimize Circuit Inductance
- Ideal For Synchronous Regulator Application

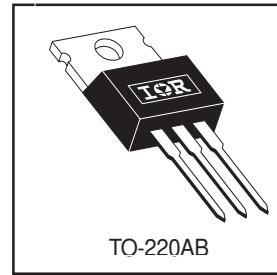


$V_{DSS} = 30V$   
 $R_{DS(on)} = 0.014\Omega$   
 $I_D = 54A$

**Description**

The FETKY family of copackaged HEXFET power MOSFETs and Schottky Diodes offer the designer an innovative board space saving solution for switching regulator applications. A low on resistance Gen 5 MOSFET with a low forward voltage drop Schottky diode and minimized component interconnect inductance and resistance result in maximized converter efficiencies.

The TO-220 package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 watts. The low thermal resistance and low package cost of the TO-220 contribute to its wide acceptance throughout the industry.



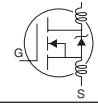
**Absolute Maximum Ratings**

	Parameter	Max.	Units
$I_D @ T_C = 25^\circ C$	Continuous Drain Current, $V_{GS} @ 10V$	54	A
$I_D @ T_C = 100^\circ C$	Continuous Drain Current, $V_{GS} @ 10V$	34	
$I_{DM}$	Pulsed Drain Current ①	220	
$P_D @ T_A = 25^\circ C$	Power Dissipation	2.0	W
$P_D @ T_C = 25^\circ C$	Power Dissipation	70	W
	Linear Derating Factor	0.56	W/ $^\circ C$
$V_{GS}$	Gate-to-Source Voltage	$\pm 16$	V
$T_J$	Operating Junction and	-55 to + 150	$^\circ C$
$T_{STG}$	Storage Temperature Range		
	Soldering Temperature, for 10 seconds	300 (1.6mm from case )	$^\circ C$
	Mounting torque, 6-32 or M3 screw	10 lbf•in (1.1N•m)	

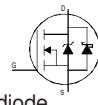
**Thermal Resistance**

	Parameter	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case	—	1.8	$^\circ C/W$
$R_{\theta JA}$	Junction-to-Ambient	—	62	

**MOSFET Electrical Characteristics @  $T_J = 25^\circ\text{C}$  (unless otherwise specified)**

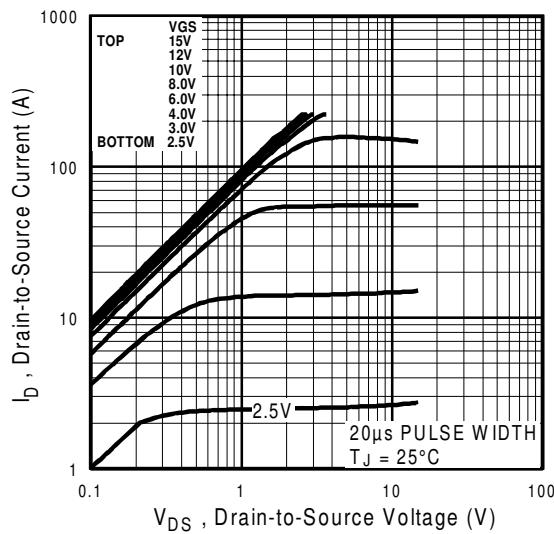
	Parameter	Min.	Typ.	Max.	Units	Conditions
$V_{(\text{BR})\text{DSS}}$	Drain-to-Source Breakdown Voltage	30	—	—	V	$V_{\text{GS}} = 0\text{V}$ , $I_D = 250\mu\text{A}$
$\Delta V_{(\text{BR})\text{DSS}/\Delta T_J}$	Breakdown Voltage Temp. Coefficient	—	0.037	—	V/ $^\circ\text{C}$	Reference to $25^\circ\text{C}$ , $I_D = 1\text{mA}$ ③
$R_{\text{DS}(\text{on})}$	Static Drain-to-Source On-Resistance	—	—	0.014	$\Omega$	$V_{\text{GS}} = 10\text{V}$ , $I_D = 32\text{A}$ ②
		—	—	0.019		$V_{\text{GS}} = 4.5\text{V}$ , $I_D = 27\text{A}$ ②
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	1.0	—	—	V	$V_{\text{DS}} = V_{\text{GS}}$ , $I_D = 250\mu\text{A}$
$g_{\text{fs}}$	Forward Transconductance	23	—	—	S	$V_{\text{DS}} = 25\text{V}$ , $I_D = 34\text{A}$ ③
$I_{\text{DSS}}$	Drain-to-Source Leakage Current	—	—	0.25	$\text{mA}$	$V_{\text{DS}} = 30\text{V}$ , $V_{\text{GS}} = 0\text{V}$
		—	—	35		$V_{\text{DS}} = 24\text{V}$ , $V_{\text{GS}} = 0\text{V}$ , $T_J = 125^\circ\text{C}$
$I_{\text{GSS}}$	Gate-to-Source Forward Leakage	—	—	100	$\text{nA}$	$V_{\text{GS}} = 16\text{V}$
	Gate-to-Source Reverse Leakage	—	—	-100		$V_{\text{GS}} = -16\text{V}$
$Q_g$	Total Gate Charge	—	—	44	$\text{nC}$	$I_D = 32\text{A}$
$Q_{\text{gs}}$	Gate-to-Source Charge	—	—	14		$V_{\text{DS}} = 24\text{V}$
$Q_{\text{gd}}$	Gate-to-Drain ("Miller") Charge	—	—	24		$V_{\text{GS}} = 4.5\text{V}$ , See Fig. 6 ②
$t_{\text{d}(\text{on})}$	Turn-On Delay Time	—	9.0	—	$\text{ns}$	$V_{\text{DD}} = 15\text{V}$
$t_r$	Rise Time	—	210	—		$I_D = 34\text{A}$
$t_{\text{d}(\text{off})}$	Turn-Off Delay Time	—	20	—		$R_G = 3.4\Omega$ , $V_{\text{GS}} = 4.5\text{V}$
$t_f$	Fall Time	—	54	—		$R_D = 0.43\ \Omega$ , ②③
$L_D$	Internal Drain Inductance	—	4.5	—	$\text{nH}$	Between lead, 6mm (0.25in.) from package and center of die contact
$L_S$	Internal Source Inductance	—	7.5	—		
$C_{\text{iss}}$	Input Capacitance	—	2300	—	$\text{pF}$	$V_{\text{GS}} = 0\text{V}$
$C_{\text{oss}}$	Output Capacitance	—	1100	—		$V_{\text{DS}} = 25\text{V}$
$C_{\text{rss}}$	Reverse Transfer Capacitance	—	310	—		$f = 1.0\text{MHz}$ , See Fig. 5
$C_{\text{iss}}$	Input Capacitance	—	3500	—		$V_{\text{GS}} = 0\text{V}$ , $V_{\text{DS}} = 0\text{V}$

**Body Diode & Schottky Diode Ratings and Characteristics**

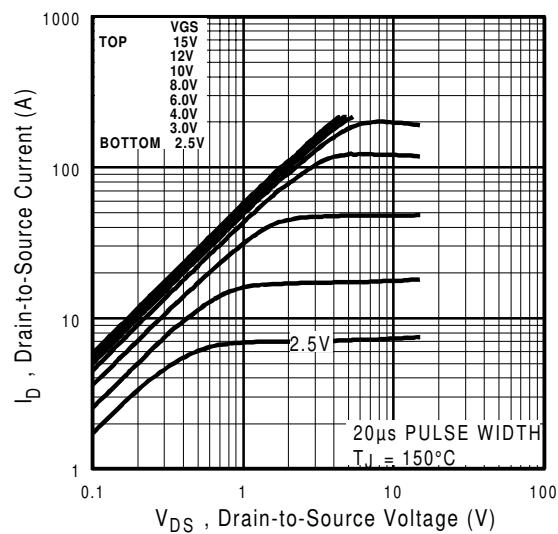
	Parameter	Min.	Typ.	Max.	Units	Conditions
$I_F (\text{AV})$	( Schottky)	—	—	5.0	$\text{A}$	MOSFET symbol showing the integral reverse p-n junction and Schottky diode. 
$I_{\text{SM}}$	Pulsed Source Current (Body Diode) ①	—	—	220		
$V_{\text{SD}1}$	Diode Forward Voltage	—	—	1.3	V	$T_J = 25^\circ\text{C}$ , $I_S = 32\text{A}$ , $V_{\text{GS}} = 0\text{V}$ ②
$V_{\text{SD}2}$	Diode Forward Voltage	—	—	0.6	V	$T_J = 25^\circ\text{C}$ , $I_S = 3.0\text{A}$ , $V_{\text{GS}} = 0\text{V}$ ②
$t_{\text{rr}}$	Reverse Recovery Time	—	51	77	ns	$T_J = 25^\circ\text{C}$ , $I_F = 32\text{A}$
$Q_{\text{rr}}$	Reverse Recovery Charge	—	47	71	nC	$dI/dt = 100\text{A}/\mu\text{s}$ ②
$t_{\text{on}}$	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by $L_S+L_D$ )				

**Notes:**

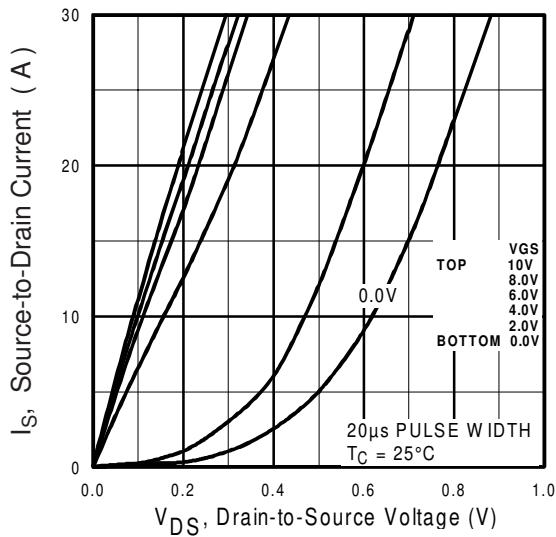
- ① Repetitive rating; pulse width limited by max. junction temperature. ( See fig. 10 )
- ② Pulse width  $\leq 300\mu\text{s}$ ; duty cycle  $\leq 2\%$ .
- ③ Uses IRL3103 data and test conditions



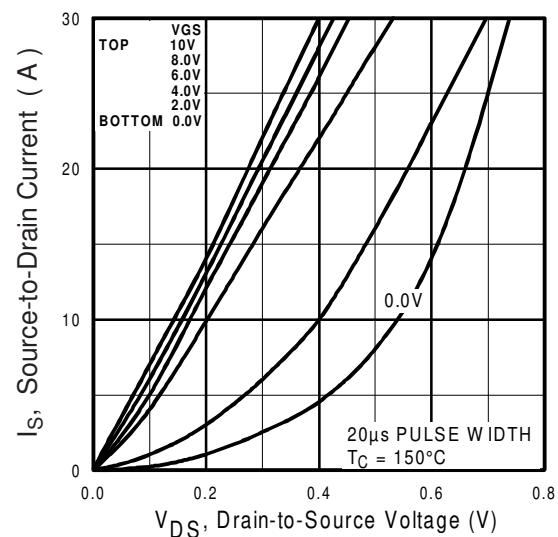
**Fig 1.** Typical Output Characteristics



**Fig 2.** Typical Output Characteristics



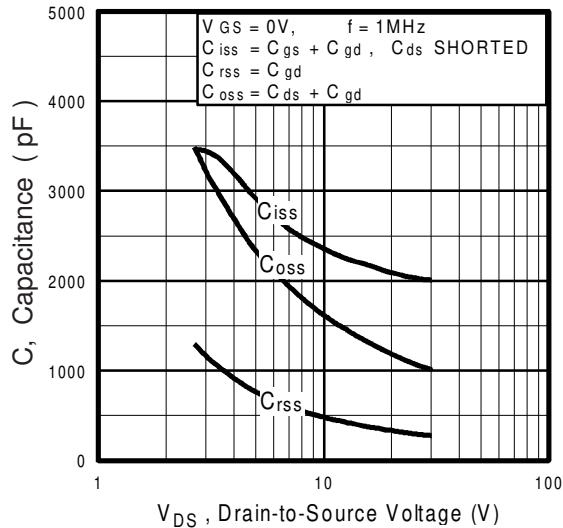
**Fig 3.** Typical Reverse Output Characteristics



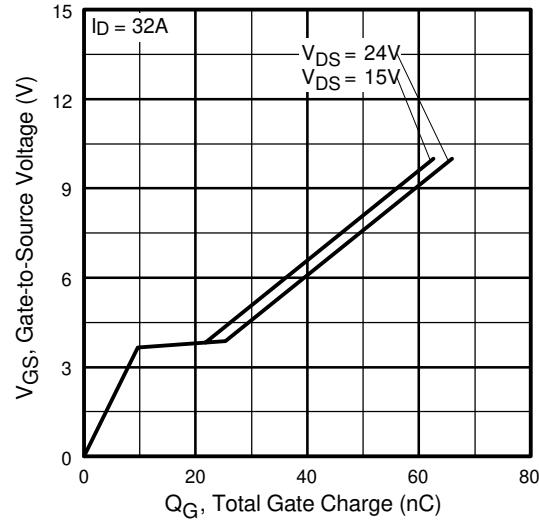
**Fig 4.** Typical Reverse Output Characteristics

# IRL3103D2

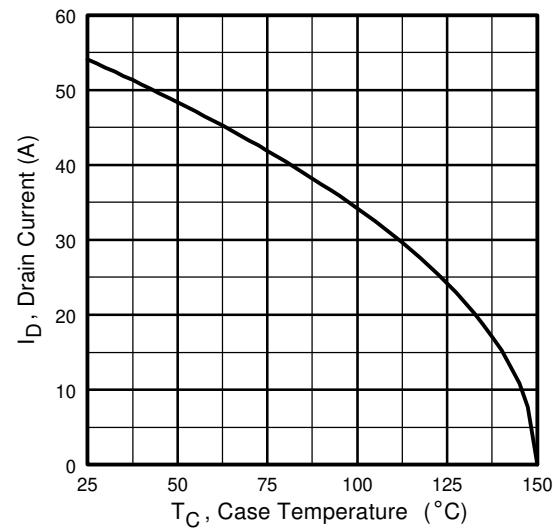
International  
**IR** Rectifier



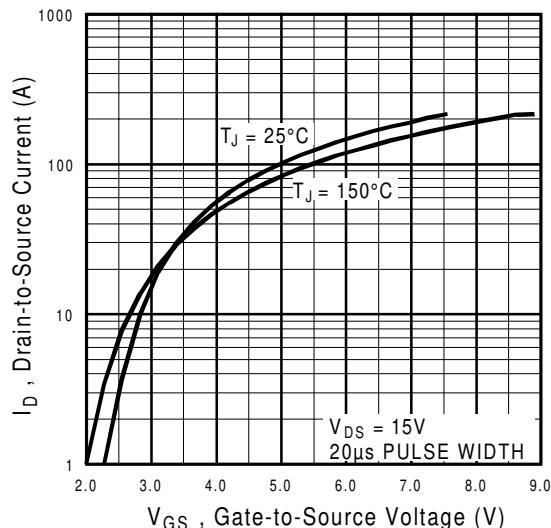
**Fig 5.** Typical Capacitance Vs.  
Drain-to-Source Voltage



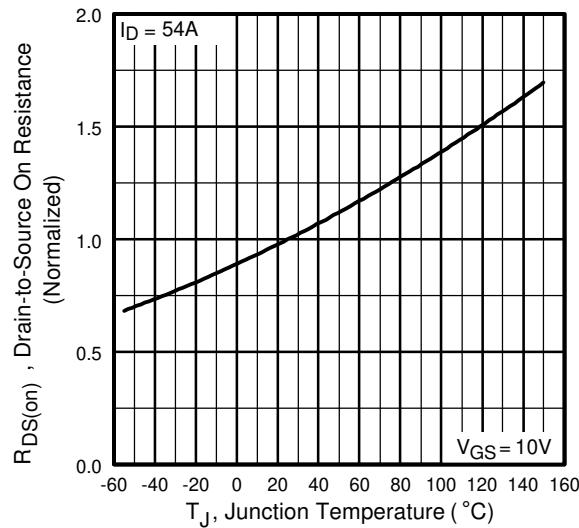
**Fig 6.** Typical Gate Charge Vs.  
Gate-to-Source Voltage



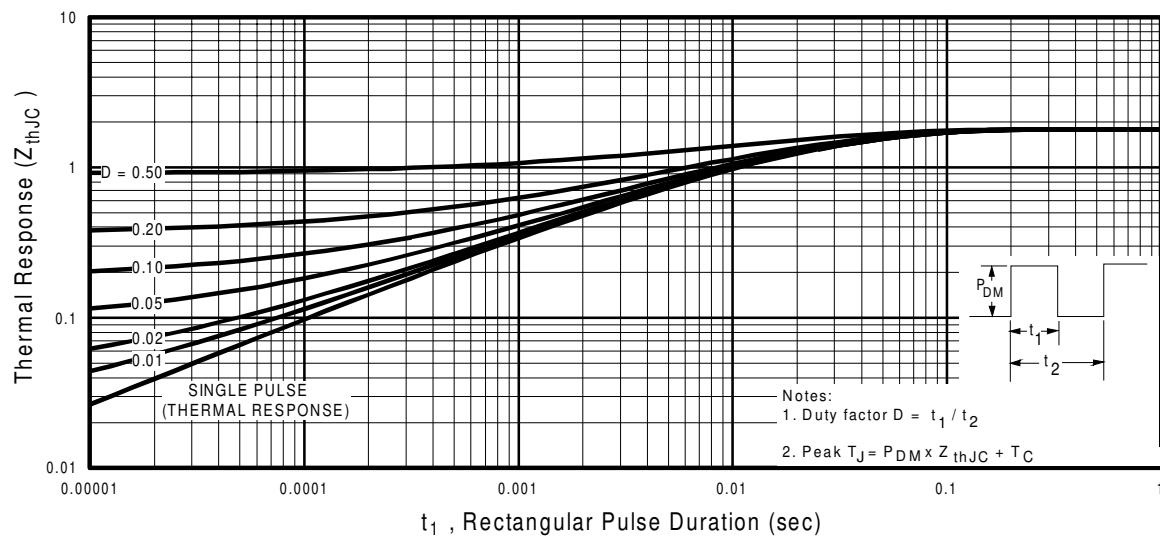
**Fig 7.** Maximum Drain Current Vs.  
Case Temperature



**Fig 8.** Typical Transfer Characteristics



**Fig 9.** Normalized On-Resistance  
Vs. Temperature



**Fig 10.** Maximum Effective Transient Thermal Impedance, Junction-to-Case

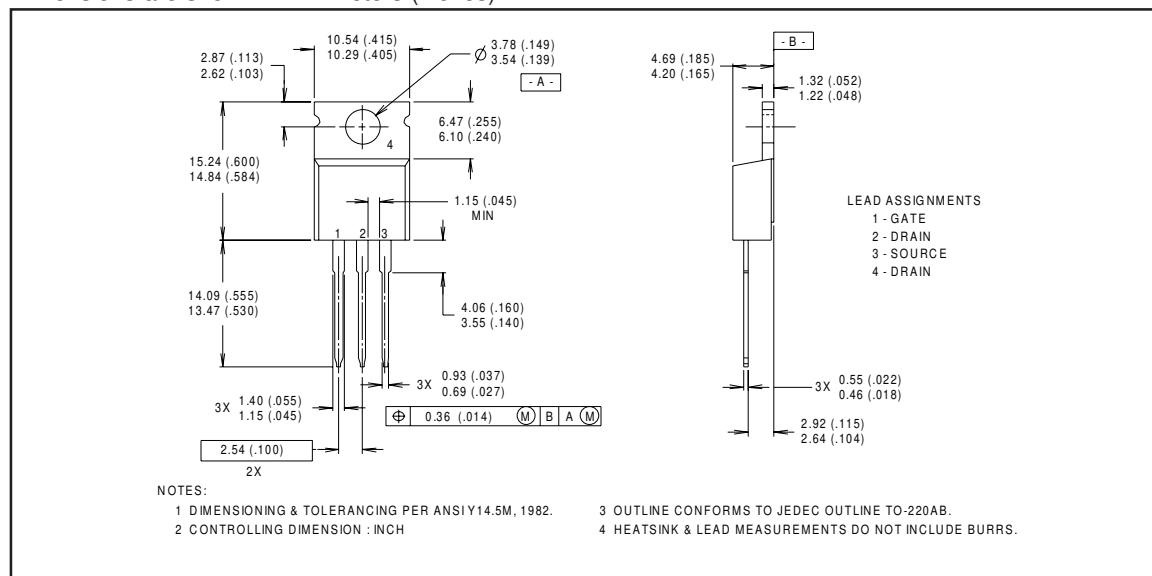
IRL3103D2

International  
**IR** Rectifier

## Package Outline

## **TO-220AB Outline**

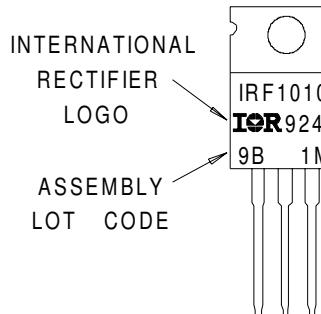
Dimensions are shown in millimeters (inches)



## Part Marking Information

### TO-220AB

EXAMPLE : THIS IS AN IRF1010  
WITH ASSEMBLY  
LOT CODE 9B1M



DATE CODE  
(YYWW)  
YY = YEAR  
WW = WEEK

# International **IR** Rectifier

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**IR SOUTHEAST ASIA:** 215 Outram Road, #10-02 Tan Boon Liat Building, Singapore 0216 Tel: 65 221 2272

IR SOUTHEAST ASIA: 315 Outram Road, #10-02, an Boon Liat Building, Singapore 0316 Tel: 65 221 8371  
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Note: For the most current drawings please refer to the IR website at:  
<http://www.irf.com/package/>